

## BRDS Reliability Test results

June 15, 2018 OS Design DEPT.3

Approved

Yoshimichi Hirokawa

Prepared

Vasubiro Masuva

No.	Test Item	Testing conditions	Conditions of acceptability	Number of samples	Number of failures
1	Heat cycle test	(1) -40°C∼125°C 30minutes each (2) 800cycles	(1)No degradation of electric characteristics after test.	5	0
2	High temperature/ High humidity bias test	(1) Ta=85°C,RH=85% (2) At rated input (3) Load 0% (4) 1000hours	(1)No degradation of electric characteristics after test.	5	0
3	Soldering heat test	(1) 260°C,15seconds (2) Mounting board: t=1.6mm / FR-4	(1)No crack at solder joint. (2)No marked damage of appearance.	1	0
4	Soldering test	(1) Pre-process Vapor agein(100℃/100%),1H Flux treatment (2) Soldering 235℃±5℃,2seconds	(1)Over 95% of dipped part is covered with solder.	1	0
5	Pin strength test immunity test	<ul><li>(1) Weight: 2kg</li><li>(2) Bending angle:90 deg., total 180 deg.</li><li>(3) 1 cycle</li></ul>	(1)No degration of electric characteristics after test. (2)No broken or bent pin.	5	0